NXP

Customer Information Notification

201308007I

Issue Date: 13-Aug-2013
Effective Date: 16-Aug-2013

Here's your personalized quality information concerning products from NXP.

For detailed information we invite you to view this notification online

QUALITY

Management Summary

For several RTC products we adapted the SPI-bus timing parameters to more realistic values.

Change Category

Wafer Fab process	Assembly Process	Product Marking	Design
Wafer Fab materials	Assembly Materials	Electrical spec./Test coverage	Mechanical Specification
Wafer Fab location	Assembly Location	Test Location	Packing/Shipping/Labeling

SPI-bus timing parameters adapted for several Real Time Clocks

Information Notification

For the mentioned Real Time Clock (RTC) products we adapted the SPI bus timing in a way that is more realistic for the customer to fulfil. Details can be found in the attached new datasheets' "revision History" chapter.

Why do we issue this Information Notification

This is mainly an errata correction.

Identification of Affected Products

Product identification does not change

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Existing inventory will be shipped until depleted

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.
Customer Focus, Passion to Win.

NXP Quality Management Team.

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A global semiconductor company with operations in more than 25 countries, NXP posted unaudited revenue of $4.36 billion in 2012.

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